

2. (Amended) The field effect transistor according to claim 1, wherein:
said channel area is comprised of a polycrystal silicon film.
3. (Amended) The field effect transistor according to claim 2, wherein:
the non-overlapped area portion of said channel area has a length longer than
a crystal grain size of the polycrystal silicon that comprises said channel area.
4. (Amended) The field effect transistor according to claim 1, wherein:
said channel area is comprised of an intrinsic semiconductor.
- 91 5. (Amended) The field effect transistor according to claim 4, wherein:
the non-overlapped area portion of said channel area contains injected
impurities of less than $1 \text{ e}^{-18}/\text{cm}^3$.
6. (Amended) The field effect transistor according to claim 1, wherein:
said gate electrode is provided on an opposite side of a substrate,
which includes said channel area, from said channel area.
7. (Amended) The field effect transistor according to claim 1, wherein:
said gate electrode is provided between said channel area and a
substrate that includes said channel area.
8. (Amended) The field effect transistor according to claim 1, wherein:
at least a part of said gate electrode overlaps one of said first and
second source areas in plan.
9. (Amended) An insulated gate type field effect transistor having a gate
electrode overlapping a channel area between a first conductivity type source area
and a second conductivity type source area thereof, wherein:

said channel area provides a single channel between said first and second source areas and said gate electrode comprises two separate subgate electrodes disposed on respective sides of said first and second conductivity type source areas in a direction in which said channel area extends.

10. (Amended) The field effect transistor according to claim 9, wherein:
said channel area is comprised of an intrinsic semiconductor.

11. (Amended) The field effect transistor according to claim 10, wherein:
the channel area includes a non-overlapped area portion free from being overlapped by the gate electrode in plan and the area portion of said channel area contains injected impurities of less than $1 \text{ e}^{-18}/\text{cm}^3$.

12. (Amended) A double field effect transistor device of an insulated gate type, comprising:

a channel area taking a virtually H-type form in plan;

a first pair of source areas different in conductivity type from one another respectively formed at opposite ends of one of a pair of parallel strips that comprises a part of the H, wherein a first single channel is provided in said channel area coupling between both of said first pair of source areas;

a second pair of source areas different in conductivity type from one another respectively formed at opposite ends of the other of said pair of parallel strips that comprises a part of the H so that the source areas formed respectively at the ends of said pair of parallel strips extending in the same direction are different in conductivity type, wherein a second single channel is provided in said channel area coupling between both of said second pair of source areas; and

a gate electrode lapping over an area of the H that comprises the central portions of said pair of parallel strips that comprises a part of the H and a central link of the H that combines said pair of parallel strips.

13. (Amended) The field effect transistor according to claim 12, wherein:
said channel area is comprised of an intrinsic semiconductor.

14. (Amended) The field effect transistor according to claim 13, wherein:
the channel area includes a non-overlapped area portion free from
being overlapped by the gate electrode in plan and the area portion of said channel
area contains injected impurities of less than $1 \text{ e}^{-18}/\text{cm}^3$.

AI 15. (Amended) An image display apparatus comprising a display unit of a
plurality of pixels formed on an insulating substrate, and a controller formed on the
insulating substrate for at least processing a display signal and for writing the display
signal to said display unit, wherein:

at least part of said controller is comprised of an insulated gate type
field effect transistor having a gate electrode overlapping a channel area between a
first conductivity type source area and a second conductivity type source area
thereof; and

said channel area includes a non-overlapped area portion free from
being overlapped by the gate electrode in plan.

16. (Amended) An image display apparatus comprising a display unit of a
plurality of pixels formed on an insulating substrate, and a controller formed on the
insulating substrate for at least processing a display signal and for writing the display
signal to said display unit, wherein:

at least part of said controller is comprised of an insulated gate type
field effect transistor having a gate electrode overlapping a channel area between a
first conductivity type source area and a second conductivity source area thereof;
and

said channel area includes a non-overlapped area portion free from

being overlapped by the gate electrode in plan; and said apparatus comprising:

an image control unit of said display unit being of an insulated gate type, said image control unit comprising:

a channel area taking a virtually H-type form;

a first pair of source areas different in conductivity type from one another respectively formed at opposite ends of one of a pair of parallel strips that comprises a part of the H, wherein a first single channel is provided in said channel area coupling between both of said first pair of source areas;

Q1 a second pair of source areas different in conductivity type from one another respectively formed at opposite ends of the other of said pair of parallel strips that comprises a part of the H so that the source areas formed respectively at the ends of said pair of parallel strips extending in the same direction are different in conductivity type, wherein a second single channel is provided in said channel area coupling between both of said second pair of source areas; and

a gate electrode lapping over an area of the H that comprises the central portions of said pair of parallel strips that comprises a part of the H and a central link of the H that combines said pair of parallel strips.

Please add new claims 17 – 26 as follows:

-- 17. An insulated gate field effect transistor comprising:

a first source region of a first conductivity type;

Q2 a second source region of a second conductivity type;

a channel region located between the first and second source regions;

a gate electrode overlapping a portion of said channel region; and

means for extinguishing captured electrons injected from the first source into said channel region, which captured electrons have been captured by potential barriers formed in said channel region.

18. An insulated gate field effect transistor according to claim 17, wherein said extinguishing means comprises forming said gate electrode to overlap a first portion of said channel region but not to overlap a second portion of said channel region, and applying a potential to said second source region to inject holes into said channel region in an opposite direction to the electrons injected into said channel region by said first source region.

aa 19. An insulated gate field effect transistor according to claim 17, wherein said first portion of said channel region is adjacent the first source and spaced apart from the second source.

20. An insulated gate field effect transistor having a gate electrode overlapping a channel area between a first conductivity type source area and a second conductivity type source area thereof, wherein:

said channel area comprises an area portion free from being overlapped by the gate electrode in plan,

wherein said channel area is comprised of a polycrystal silicon film, and

wherein the non-overlapped area portion of said channel area has a length longer than a crystal grain size of the polycrystal silicon that comprises said channel area.

21. An insulated gate type field effect transistor having a gate electrode overlapping a channel area between a first conductivity type source area and a second conductivity type source area thereof, wherein:

said gate electrode comprises two separate subgate electrodes

disposed on respective sides of said first and second conductivity type source areas in a direction in which said channel area extends, and
said channel area is comprised of an intrinsic semiconductor.

22. The field effect transistor according to claim 21, wherein:
the channel area includes a non-overlapped area portion free from being overlapped by the gate electrode in plan and the area portion of said channel area contains injected impurities of less than $1 \text{ e}^{-18}/\text{cm}^3$.

12 23. A double field effect transistor device of an insulated gate type, comprising:
a channel area taking a virtually H-type form in plan;
a first pair of source areas different in conductivity type from one another respectively formed at opposite ends of one of a pair of parallel strips that comprises a part of the H;
a second pair of source areas different in conductivity type from one another respectively formed at opposite ends of the other of said pair of parallel strips that comprises a part of the H so that the source areas formed respectively at the ends of said pair of parallel strips extending in the same direction are different in conductivity type; and
a gate electrode lapping over an area of the H that comprises the central portions of said pair of parallel strips that comprises a part of the H and a central link of the H that combines said pair of parallel strips.

24. The field effect transistor according to claim 23, wherein:
said channel area is comprised of an intrinsic semiconductor.

25. The field effect transistor according to claim 24, wherein:
the channel area includes a non-overlapped area portion free from

being overlapped by the gate electrode in plan and the area portion of said channel area contains injected impurities of less than $1 \text{ e}^{-18}/\text{cm}^3$.

26. An image display apparatus comprising a display unit of a plurality of pixels formed on an insulating substrate, and a controller formed on the insulating substrate for at least processing a display signal and for writing the display signal to said display unit, wherein:

at least part of said controller is comprised of an insulated gate type field effect transistor having a gate electrode overlapping a channel area between a first conductivity type source area and a second conductivity source area thereof; and

said channel area includes a non-overlapped area portion free from being overlapped by the gate electrode in plan; and said apparatus comprising:

an image control unit of said display unit being of an insulated gate type, said image control unit comprising:

a channel area taking a virtually H-type form;

a first pair of source areas different in conductivity type from one another respectively formed at opposite ends of one of a pair of parallel strips that comprises a part of the H;

a second pair of source areas different in conductivity type from one another respectively formed at opposite ends of the other of said pair of parallel strips that comprises a part of the H so that the source areas formed respectively at the ends of said pair of parallel strips extending in the same direction are different in conductivity type; and

a gate electrode lapping over an area of the H that comprises the central portions of said pair of parallel strips that comprises a part of the H and a central link of the H that combines said pair of parallel strips.